-30V, -90A, 4.2mΩ P-channel Power Trench MOSFET

JMTK060P03A

Features

- $\bullet \;\;$ Excellent $R_{DS(ON)}$ and Low Gate Charge
- 100% UIS TESTED
- 100% ΔVds TESTED
- Halogen-free; RoHS-compliant
- Pb-free plating

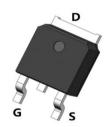
Applications

- Load Switch
- PWM Application
- Power Management

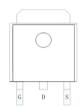
Product Summary

Parameters	Value	Unit
V_{DSS}	-30	V
$V_{GS(th)_Typ}$	-1.8	V
$I_D(@V_{GS}=-10V)$	-90	A
$R_{DS(ON)_Typ}(@V_{GS}=-10V$	4.2	mΩ
$R_{DS(ON)_Typ}(@V_{GS}=-4.5V)$	6.3	mΩ

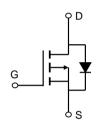








Pin Assignment



Schematic Diagram

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMTK060P03A	JMTK060P03A	3	Tape&Reel	TO-252-3L	2500	25000

Absolute Maximum Ratings (@ T_C = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		-30	V
V_{GS}	Gate-to-Source Voltage		±20	V
L	Continuous Drain Current	$T_C = 25^{\circ}C$	-90	Α
I _D	Continuous Drain Current	$T_C = 100$ °C	-57	7
I _{DM}	Pulsed Drain Current (1)		Refer to Fig.4	Α
E _{AS}	Single Pulsed Avalanche Energ	gy ⁽²⁾	398	mJ
P _D		$T_C = 25^{\circ}C$	46	W
' D	r ower Dissipation	$T_C = 100$ °C	19	
T_{J}, T_{STG}	Junction & Storage Temperature I	Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (3)	40	°C/W
Raic	Thermal Resistance, Junction to Case	2.7	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

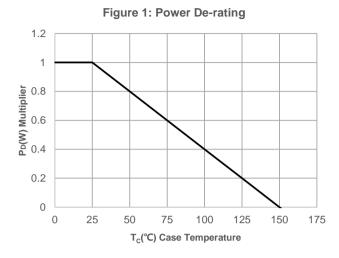
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30	•	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	-	-	-1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.3	-1.8	-2.5	V
R	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = -10V, I_D = -30A$	-	4.2	6.4	mΩ
R _{DS(ON)}	Static Drain-Source ON-Resistance	$V_{GS} = -4.5V, I_{D} = -20A$	-	6.3	10.5	mΩ
Dynami	ic Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	2.4	-	Ω
C _{iss}	Input Capacitance	\\ \ \ \ \ \\ \ \ \ \ \ \ \ \ \ \ \ \	4688	6563.7	8861	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -15V,$ f = 1MHz	488	684	923	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112	405	567	766	pF
Q_g	Total Gate Charge	14 04 404	78	110	148	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } -10V$ $V_{DS} = -15V, I_{D} = -30A$	15	22	29	nC
Q_{gd}	Gate Drain("Miller") Charge	V DS = -13 V, 1D = -30A	15	21	28	nC
Switchi	ng Characteristics					
t _{d(on)}	Turn-On DelayTime		-	12	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -10V, V_{DD} = -15V$	-	10	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = -30A$, $R_{GEN} = 3\Omega$	-	88	-	ns
t _f	Turn-Off Fall Time		-	53	-	ns
Body D	iode Characteristics					
Is	Maximum Continuous Body Diode Forward C	Current	-	-	-90	Α
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	•	-359	Α
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -30A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = -15A, di/dt = 100A/us	23	32	43	ns
Qrr	Body Diode Reverse Recovery Charge	1 _F = -13A, u//ut = 100A/us	-	22.4	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.~E_{AS}~condition:~Starting~T_J=25C,~V_{DD}=-15V,~V_G=-10V,~R_G=25ohm,~L=0.5mH,~I_{AS}=-32.76A,~V_{DD}=0V~during~time~in~avalanche.$
- 3. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.
- 4. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 0.5%.



Typical Performance Characteristics



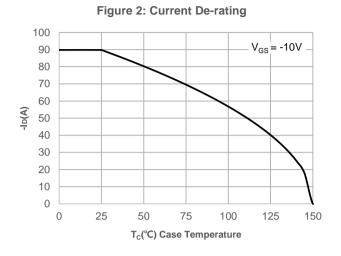
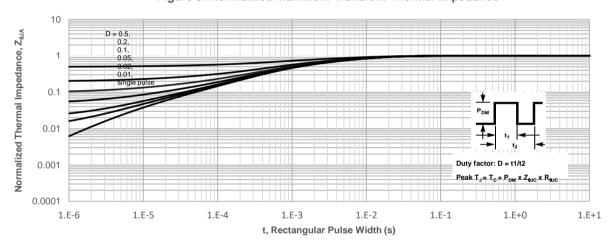
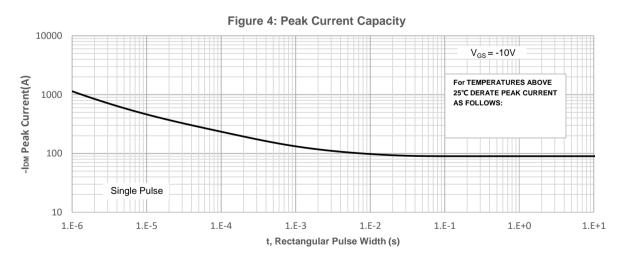


Figure 3: Normalized Maximum Transient Thermal Impedance







Typical Performance Characteristics

Figure 5: Output Characteristics

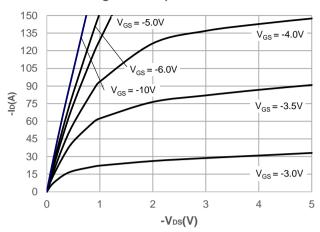


Figure 6: Typical Transfer Characteristics

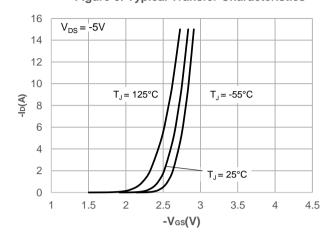


Figure 7: On-resistance vs. Drain Current

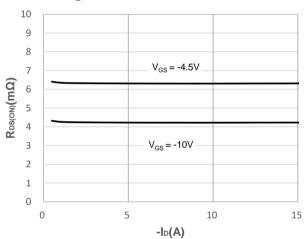


Figure 8: Body Diode Characteristics

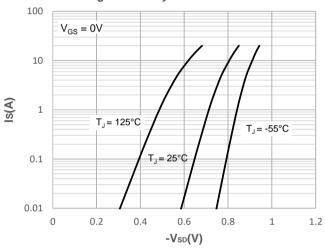


Figure 9: Gate Charge Characteristics

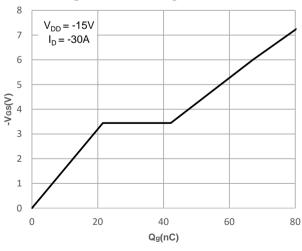
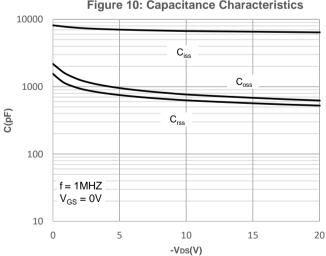


Figure 10: Capacitance Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs.
Junction Temperature

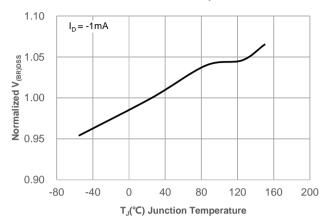


Figure 13: Normalized Threshold Voltage vs.
Junction Temperature

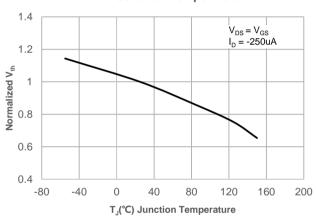


Figure 15: Maximum Safe Operating Area

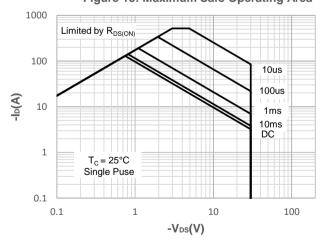
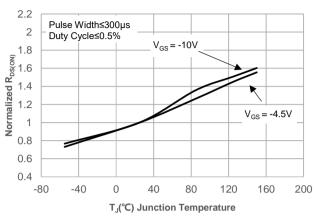
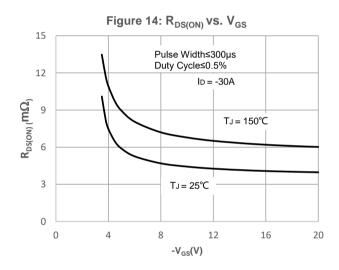


Figure 12: Normalized on Resistance vs.
Junction Temperature







Test Circuit

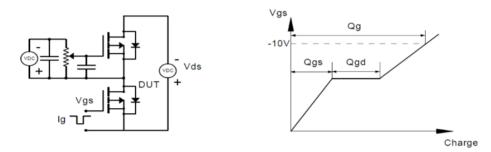


Figure 1: Gate Charge Test Circuit & Waveform

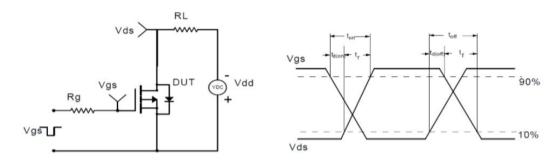


Figure 2: Resistive Switching Test Circuit & Waveform

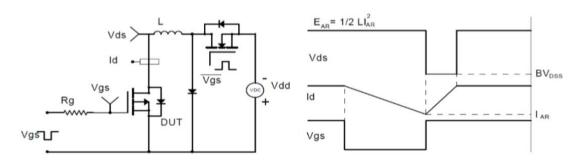


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

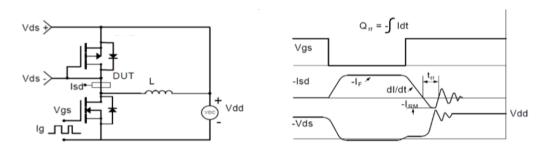
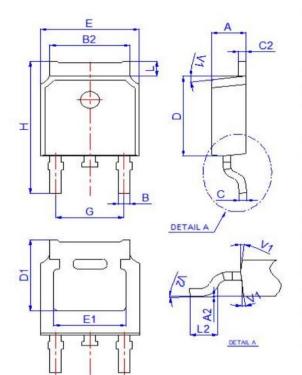


Figure 4: Diode Recovery Test Circuit & Waveform

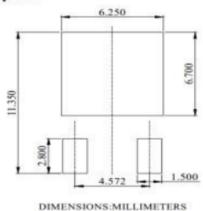


Package Mechanical Data(TO-252-3L)



			Dime	ensions		
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Recommended Soldering Footprint



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